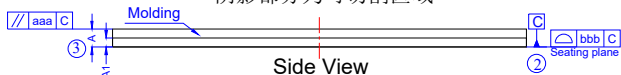
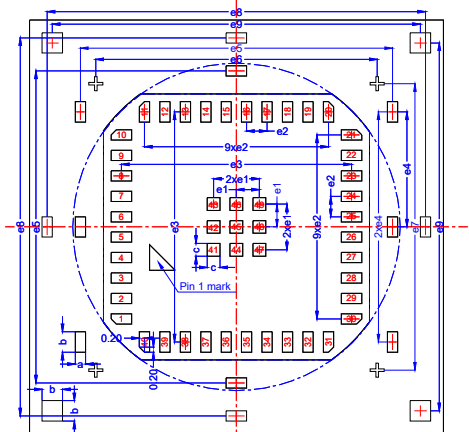


Top View
阴影部分为可切割区域



Side View



Bottom View


DIMENSIONAL REFERENCES Units:mm

SYMBOL	DIMENSIONAL REQMTS			SYMBOL	Tolerance of Form & Position
	MIN	NOM	MAX		
A	0.66	0.70	0.74	aaa	0.10
A1	0.32	0.35	0.38	bbb	
Dmax	16.10	16.20	16.30		
Dmin	10.30	10.40	10.50		
Emax	16.10	16.20	16.30		
Emin	10.30	10.40	10.50		
a	0.35	0.40	0.45		
b	0.75	0.80	0.85		
c	0.45	0.50	0.55		
e1	0.90 BCS				
e2	0.80 BCS				
e3	9.00 BCS				
e4	4.50 BCS				
e5	12.20 BCS				
e6	11.00 BCS				
e7	11.20 BCS				
e8	14.80 BCS				
e9	14.40 BCS				

Note:

- All dimensions are in mm.
- Datum 'C' is the mounting surface, with which the package is in contact
- Dimension 'A' include the package warpage.

PIN	Value	PIN	Value	PIN	Value
1	COUT	18	NCX	35	NC
2	NC	19	GND	36	NC
3	LDO_RING	20	NC	37	GND
4	TX_RING	21	NC	38	VCAL
5	VCC	22	NC	39	VTX
6	NC	23	NC	40	KEY
7	NC	24	NC	41	GND
8	NC	25	NC	42	GND
9	FINGER	26	NC	43	GND
10	INT	27	NC	44	GND
11	MOSI	28	NC	45	GND
12	MISO	29	NC	46	GND
13	CLK	30	NC	47	GND
14	CS	31	NCX	48	GND
15	NC	32	NC	49	GND
16	NC	33	NC		
17	NC	34	NC		

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图号 Drawing NO.	HY-POD-LGA0023				品质部: Quality Department		产品工程部: PE Check	
Title 产品外形图	PACKAGE OUTLINE DIMENSIONS LGA49L (16. 2X16. 2X0. 7-P0. 8)				生技部: Technical Department		生产部: Product Department	
幅图 size	页数 page	单位 unit	比例 scale	视图 view	审核: Checker		核准: Approved	
A4	1	mm	1:1	